

## **MOSFET**

#### OptiMOS<sup>™</sup>5 Power-Transistor, 100 V

#### **Features**

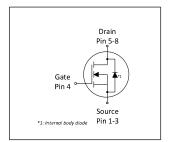
- Ideal for high frequency switching
  Optimized technology for DC/DC converters
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  N-channel, Logic level
  100% avalanche tested

- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



Parameter Value Unit								
Parameter	value	Unit						
$V_{ extsf{DS}}$	100	V						
$R_{ extsf{DS(on),max}}$	14.6	mΩ						
I <sub>D</sub>	44	A						
Qoss	20	nC						
Q <sub>G</sub> (0V4.5V)	8	nC						











Type / Ordering Code	Package	Marking	Related Links
BSZ146N10LS5	PG-TSDSON-8 FL	146N10L	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

<b>5</b>	Construction	Values			ļ., .,	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	- - -	44 28 9	A	V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C V <sub>GS</sub> =10 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =10 V, T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60K/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	176	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	30	mJ	$I_D$ =20 A, $R_{GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	52 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 K/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

Parameter	Cumbal		Values		Linia	Note / Took Condition	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	$R_{thJC}$	-	1.4	2.4	K/W	-	
Device on PCB, minimal footprint	$R_{thJA}$	-	-	62	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	$R_{thJA}$	_	_	60	K/W	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.7	2.3	V	$V_{\rm DS}$ = $V_{\rm GS}$ , $I_{\rm D}$ =23 $\mu A$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	16.0 12.4	20.8 14.6	mΩ	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =10 A V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A
Gate resistance <sup>1)</sup>	R <sub>G</sub>	-	1	1.5	Ω	-
Transconductance	$g_{fs}$	18	36	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$

 Table 5
 Dynamic characteristics

Davamatav	Symals al	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	lin. Typ. Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	1000	1300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	170	220	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	9	15	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	4.7	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	t <sub>r</sub>	-	3.2	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	14.3	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	-	3.2	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Davamatav	Symals al		Values	5	l lmi4	Note / Tost Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	$Q_{gs}$	-	3.2	-	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V	
Gate charge at threshold	$Q_{g(th)}$	-	1.6	-	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V	
Gate to drain charge <sup>1)</sup>	$Q_{ m gd}$	-	2.8	4.1	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V	
Switching charge	Q <sub>sw</sub>	-	4.4	-	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V	
Gate charge total <sup>1)</sup>	Qg	-	7.6	9.5	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V	
Gate plateau voltage	V <sub>plateau</sub>	-	3.2	-	V	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 4.5 V	
Gate charge total	Qg	-	15	-	-	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	20	27	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V	

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition



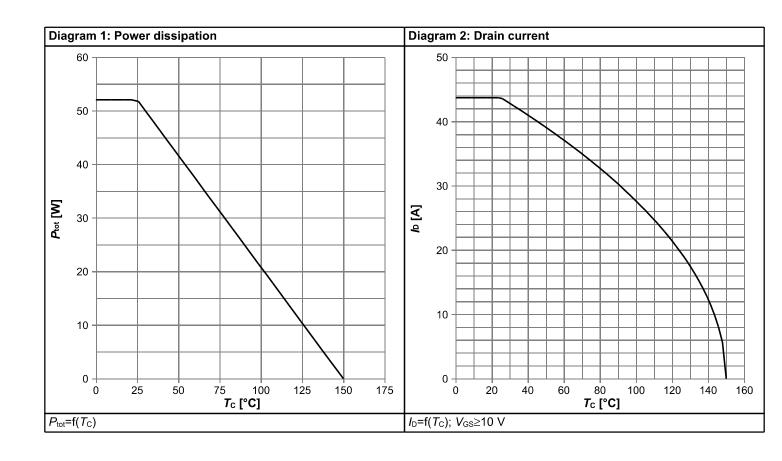
### Table 7 Reverse diode

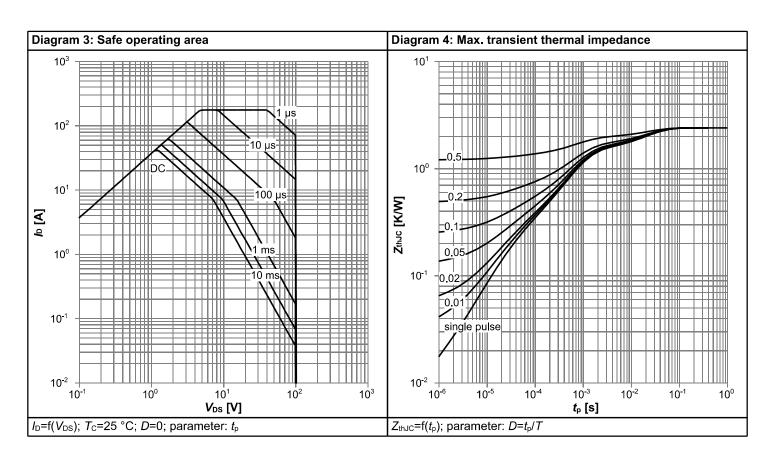
Davamatar	Cumbal		Values		l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.		Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	42	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	176	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.88	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	26	52	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	19	38	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

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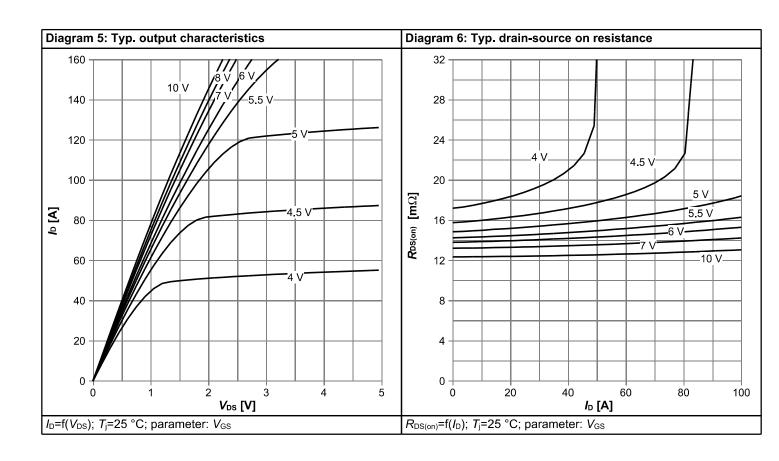


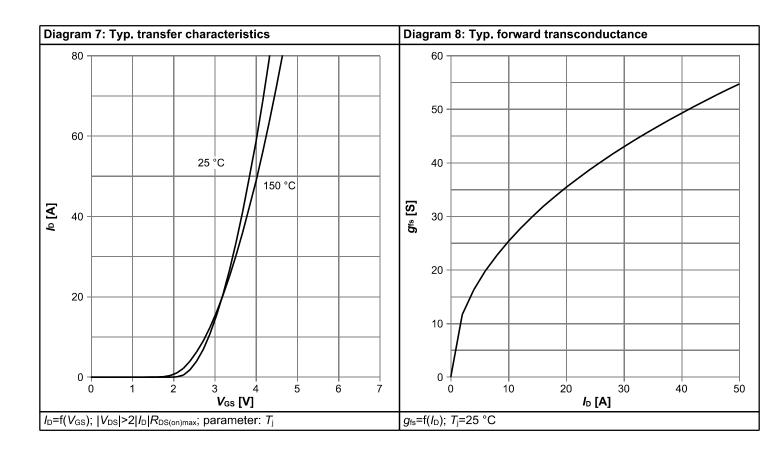
## 4 Electrical characteristics diagrams



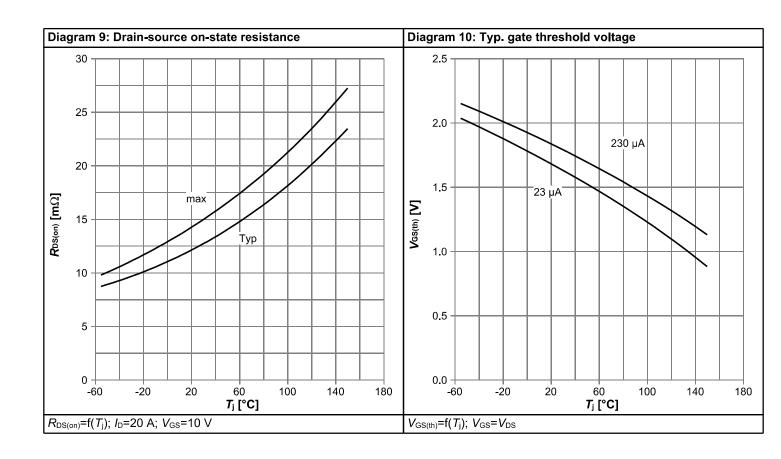


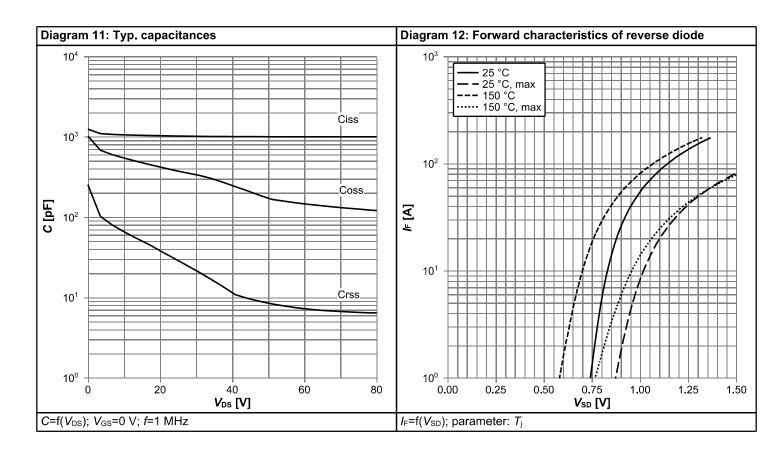




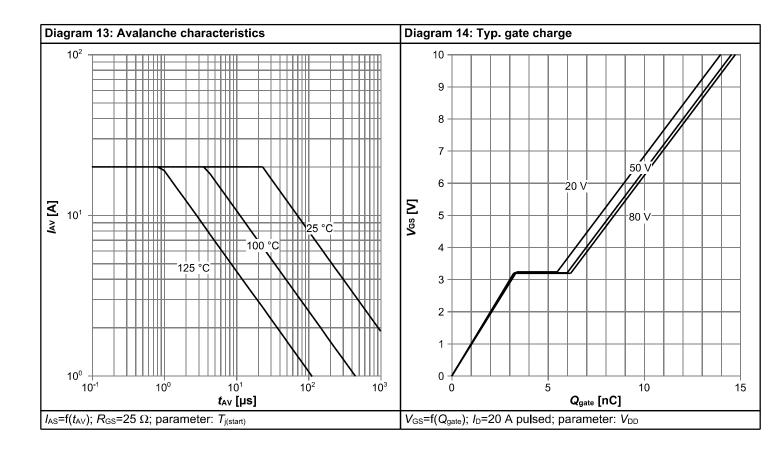


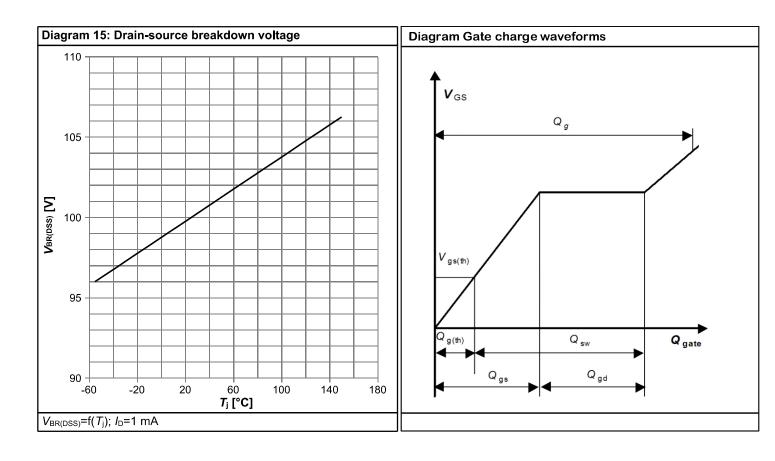






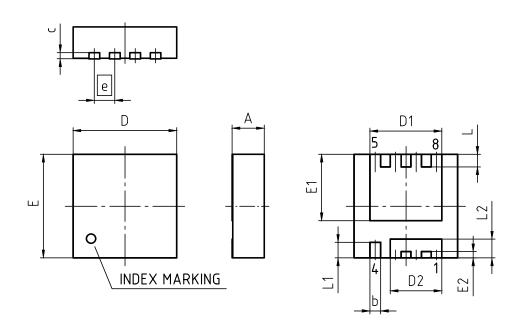








# 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-	TSDS	ON-8-U03	
REVISION: 03		DATE:	20.10.2020	
DIMENSIONS	N	MILLIM	ETERS	
DIMENSIONS	MIN	٧.	MAX.	
Α	0.9	0	1.10	
b	0.2	4	0.44	
С		(0.	20)	
D	3.2	0	3.40	
D1	2.1	9	2.39	
D2	1.5	4	1.74	
E	3.2	0	3.40	
E1	2.0	1	2.21	
E2	0.1	0	0.30	
е	0.65			
L	0.30		0.50	
L1	0.4	0	0.60	
L2	0.5	0	0.70	
aaa	·	0.0	06	

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



#### **Revision History**

BSZ146N10LS5

Revision: 2021-03-17, Rev. 2.3

#### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)
2.0	2016-03-23	Release of final version
2.1	2016-04-21	Update Gate threshold voltage (VGSth)
2.2	2016-08-10	Update in Qrr and trr
2.3	2021-03-17	Update current rating and POD

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